

1.6X0.8mm INFRARED EMITTING DIODE

Part Number: KP-1608F3C

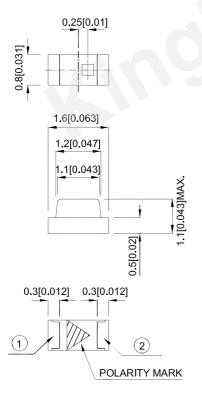
Features

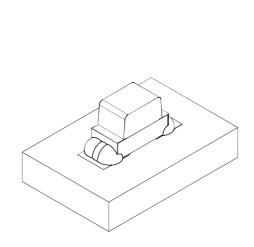
- 1.6mmX0.8mm SMD LED, 1.1mm thickness.
- Mechanically and spectrally matched to the phototransistor.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

F3 Made with Gallium Arsenide Infrared Emitting diodes.

Package Dimensions





- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.
- 3.The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 4.The device has a single mounting surface. The device must be mounted according to the specifications.





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Selection Guide

| Part No. | Emitting Color (Material) | Lens Type | Po (mW/sr) [2] @ 20mA | | Viewing Angle [1] |
|------------|---------------------------|-------------|--------------------------|------|----------------------|
| | | | Min. | Тур. | 201/2 |
| KP-1608F3C | Infrared (GaAs) | Mater Class | 1.2 | 3 | 150° |
| | | Water Clear | *0.8 | *2 | |

Notes:

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Radiant Intensity/ luminous flux: +/-15%.
 * Radiant intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

| Parameter | P/N | Symbol | Тур. | Max. | Units | Test Conditions |
|--------------------------|-----|--------|------|------|-------|---------------------|
| Forward Voltage [1] | F3 | VF | 1.2 | 1.6 | V | IF=20mA |
| Reverse Current | F3 | lR | | 10 | uA | V _R = 5V |
| Capacitance | F3 | С | 90 | | pF | VF=0V;f=1MHz |
| Peak Spectral Wavelength | F3 | λP | 940 | | nm | IF=20mA |
| Spectral Bandwidth | F3 | Δλ1/2 | 50 | | nm | IF=20mA |

Note:

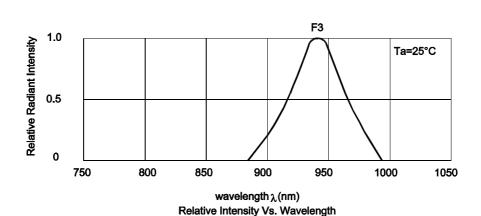
- 1. Forward Voltage: +/-0.1V.
 2. Wavelength value is traceable to CIE127-2007 standards.
 3. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

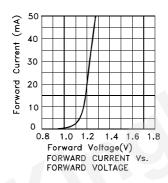
| A to Column and Training Cut 171 20 C | | | | | | |
|---------------------------------------|--------|------------|-------|--|--|--|
| Parameter | Symbol | Values | Units | | | |
| Power dissipation | PD | 80 | mW | | | |
| DC Forward Current | lF | 50 | mA | | | |
| Peak Forward Current [1] | iFS | 1.2 | Α | | | |
| Reverse Voltage | VR | 5 | V | | | |
| Operating Temperature | Та | -40 To +85 | °C | | | |
| Storage Temperature | Тѕтс | -40 To +85 | °C | | | |

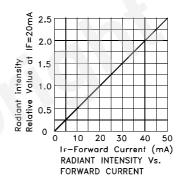
- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

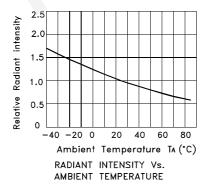
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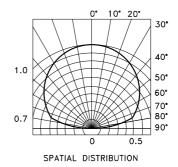


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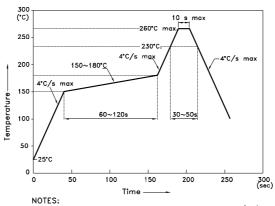


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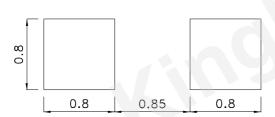
Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.

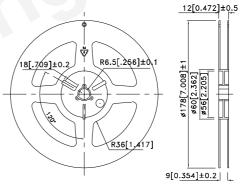


1.We recommend the reflow temperature $245^{\circ}C(+/-5^{\circ}C)$.The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 3.Number of reflow process shall be 2 times or less.

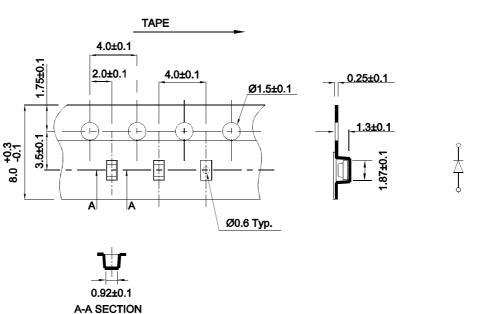
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Reel Dimension



Tape Specifications (Units: mm)



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PACKING & LABEL SPECIFICATIONS KP-1608F3C User Direction of Feed Label-2,000pcs / Reel 1Reel / Bag Outside Outside Label Kingbright 30K / 55# Box 60K / 56# Box Kingbright P/NO: KP-1608XXX QC QTY: 2,000 pcs XX XX XXXX S/N: XXXX PASSED CODE: XXX LOT NO:

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RoHS Compliant

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